



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Appl. No. : 10/823,970
Applicant : OGAWA, et al.
Filed : 13 April 2004
Art Unit : 2818
Examiner : Hoang, Quoc Dinh
Attorney :
Docket No. : AMD-AF01215

Confirmation No. 5318

For: SEMICONDUCTOR DEVICE HAVING
A PAD METAL LAYER AND A LOWER METAL
LAYER THAT ARE ELECTRICALLY
COUPLED, WHEREAS APERTURES ARE
FORMED IN THE LOWER METAL LAYER
BELOW A CENTER AREA OF THE PAD
METAL LAYER

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT AND RESPONSE RCE

Dear Sir:

In response to the Final Office Action dated December 23rd, 2005, and the notice of panel decision dated April 10, 2006, Applicants respectfully submit the following regarding the above captioned patent application. Amendments to the Claims begin on page 2 of this response. Remarks begin on page 5 of this response.

06/27/2006 HVUONG1 00000080 10823970

02 FC:1252

450.00 OP

AMD-AF01215
Examiner: Hoang, Quoc Dinh

1 of 7

Serial No.: 10/823,970
Group Art Unit: 2818